

Coilmaster



SPECIFICATION APPROVAL

| CUSTOMER | : | Dachs |
|-----------|------|-----------------|
| PRODUCT | • | MF0603T-6N8J-LF |
| | | Pb-free |
| CODE NO. | : | C01706001 |
| CUS. CODE | : | |
| SPEC.NO. | : | C-1706-001(00) |
| DATE | : | 14-Dec-07 |
| CU | STON | MER APPROVAL |
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Coilmaster Electronics Co., Ltd.

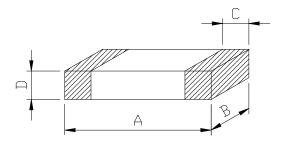
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| PREPARED BY | APPROVED BY | AUTHORIZED BY |
|-------------|-------------|---------------|
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CONFIGURATION & DIMENSIONS:



 $\begin{array}{cccccccc} A & : & 0.60 {\pm} 0.05 & & m/m \\ B & : & 0.30 {\pm} 0.05 & & m/m \\ C & : & 0.15 {\pm} 0.05 & & m/m \\ D & : & 0.23 {\pm} 0.05 & & m/m \end{array}$

ELECTRICAL CHARACTERISTIC:

INDUCTANCE AT500 MHz 250mV : 6.8nH $\pm 5\%$

 $SRF(GHz): & 4.0 & Min. \\ DC & RESISTANCE(\Omega): & 2.3 & Max. \\ IDC & (mA): & 130 & Max. \\ Q & AT & 500MHZ: & 8.0 & Min. \\ \end{cases}$

STANDARD ATMOSPHERIC CONDITIONS

Unless otherwise specified the standard range of atmospheric conditions for making measurements and tests is as follows:

Ambient temperature : $20\pm15^{\circ}$ C Relative humidity : $65\pm20\%$

If there may be any doubt on the results, measurements shall be made within

the following limits:

Ambient temperature : $25\pm5^{\circ}$ C Relative humidity : $75\pm10\%$

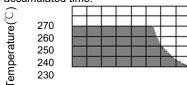
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6) Reflow soldering conditions

 Pre—heating should be in such a way that the temperature difference between solder and ferrite surface is limited to 150°C max. Also cooling into solvent after soldering should be in such a way that the temperature difference is limited to 100°C max.

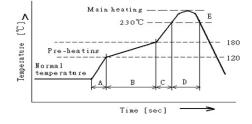
Unenough pre—heating may cause cracks on the ferrite, resulting in the deterioration of product quality.

Products should be soldered within the following allowable range indicated by the slanted line.
 The excessive soldering conditions may cause the corrosion of the electrode, When soldering is repeated, allowable time is the accumulated time.



0 10 20 30 40 50 60 70

Temperature Profile



| Slope of temp. rise | 1 to 5 | °C/sec |
|---------------------|--|--|
| Heat time | 50 to 150 | sec |
| Heat temperature | 120 to 180 | $^{\circ}$ |
| Slope of temp. rise | 1 to 5 | °C/sec |
| Time over 230°C | 90~120 | sec |
| Peak temperature | 255~260 | $^{\circ}\!\mathbb{C}$ |
| Peak hold time | 10 max. | sec |
| * No. of mounting | 3 | times |
| | Heat time Heat temperature Slope of temp. rise Time over 230°C Peak temperature Peak hold time | Heat time 50 to 150 Heat temperature 120 to 180 Slope of temp. rise 1 to 5 Time over 230°C 90~120 Peak temperature 255~260 Peak hold time 10 max. |

(Melting area of solder)

6-1 Reworking with soldering iron

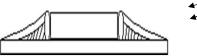
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|-----------------------|---------------|
| Preheating | 150℃, Iminute |
| Tip temperature | 280℃ max |
| Soldering time | 3seconds max. |
| Soldering iron output | 30w max. |
| End of soldering iron | ∮ 3mm max. |

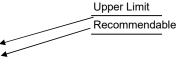
• Reworking should be limited to only one time.

Note: Do not directly touch the products with the tip of the soldering iron in order to prevent the crack on the ferrite material due to the thermal shock.

6-2 Solder Volume

Solder shall be used not to be exceed the upper limits as shown below.





Accordingly increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance.

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⁷ EQUIPMENT

7-1 IMPEDANCE

Impedance shall be measured with HP $-4286\mathrm{A}$ impedance analyzer or equivalent system

7-2 DC RESISTANCE

DC resistance shall be measured using HP 4338 digital mili—ohm meter with 4 terminal method.

8.MECHANICAL CHARACTERISTICS

| ITEM | Specification | TEST CONDITIONS |
|--------------|---|---|
| TERMINAL | Without deformation cases | Solder chip on PCB and applied 10N |
| STRENGTH | impedance shall be satisfied ± 30% | (1.02Kgf) for 10 sec |
| | DC resistance shall be satisfied. | CHIP BEAD |
| Substrate | Without deformation cases, | After soldering a chip to a test substrate, |
| bending test | impedance shall be satisfied ± 30% | bend the substrate by 3mm hold for 10s |
| | DC resistance shall be satisfied. | and then return. |
| | | Soldering shall be done in accordance |
| | | with the recommended PC board pattern |
| | | and reflow soldering. |
| | | unit : mm |
| RESISTANCE | No visible damage | Solder Temp. : 265±3℃ |
| TO SOLDER | Electrical characteristics and mechanical characteristics shall be satisfied. | Immersion time : 6±1 sec |
| HEAT | | Preheating : 100℃ to 150℃, 1 minute. |
| | | Measurement to be made after keeping at room temp for 24±2 hrs. |
| | | Solder : Sn-3Ag-0.5Cu |
| SOLDER— | 95% min. coverage of all | Solder temp.: 240±5°C |
| ABILITY | metabolised area | Immersion time : 3±1 sec |
| | | Solder : Sn-3Ag-0.5Cu |

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9. RELIABILITY AND TEST CONDITIONS

9-1 HIGH TEMPERATURE RESISTANCE

- a. Performance specification
- 1.Appearance: no mechanical damage
- 2.Impedance shall be with ±30% of the initial value
- 3. DC resistance shall be satisfied
- b.Test condition
- 1.Temperature125°C±2°C
- 2.Applied current : Rated current(maximum value)
- 3.Testing time: 96±4hrs
- 4. Measurement: After placing at room ambient temperature for 1 hours minimum

9-2 HUMIDITY RESISTANCE

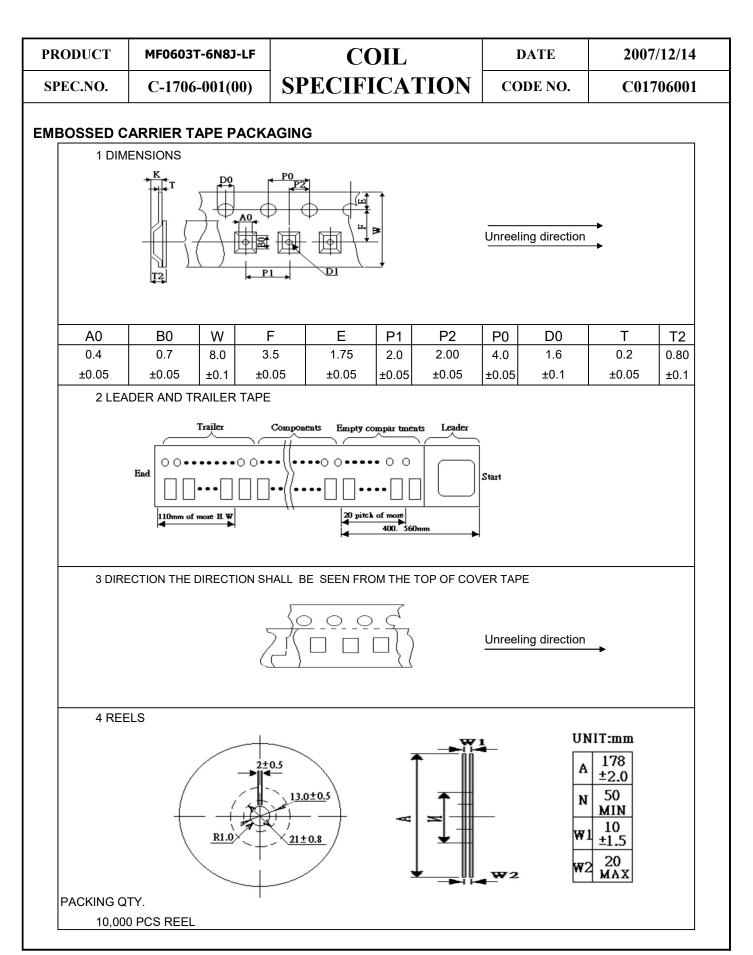
- a.Performance specification
- 1.Appearance: no mechanical damage
- 2.Impedance:within ±30% of initial value
- 3.DC resistance shall be satisfied
- b.Test condition
- 1.Humidity : 90 to 95% RH2.Temperature : 60±2°C
- 3.Applied current: Rated current (maximum value)
- 4.Testing tine: 500±4hours
- 5.Measurement: After placing at room ambient temperature for 1 hours minimum

9-3 TEMPERATURE CYCLE

- a.Performance specification
- 1.Appearance: no mechanical damage
- 2.Impedance:within ±30% of initial value
- 3. DC resistance shall be satisfied
- b.Test condition
- 1.Temperature -55°C ,+125°C kept stabilized for 30 minutes each
- 2.Cycle: 100 cycles
- 3.Measurement: After placing for 1 hours minimum at room ambient temperature
- 4. step1. -55°C temp±3°C 30±3 minutes
 - step2. Standard atmospheric conditions 5s or less
 - step3. +125°C temp±2°C 30±3 minutes
 - step4. Standard atmospheric conditions 5s or less

9-4 LOW TEMPERATURE STORAGE LIFE TEST

- a.Performance specification
- 1.Appearance: no mechanical damage
- 2.Impedance shall be with ±30% of the initial value
- 3. DC resistance shall be satisfied
- b.Test condition
- 1.Temperature -55°C ±2°C
- 2.Testing time: 1008±12hours
- 3. Measurement: After placing for 24 hours minimum at room ambient temperature



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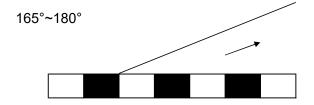
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10-5 PULLING STRENGTH OF TAPES

| Carrier tape | (1kgf or more) |
|--------------|------------------|
| Cover tape | (0.5kgf or more) |

10-6 PEELING STRENGTH OF COVER TAPE

| Cover tape | (20g~120g) |
|------------|------------|



Test condition

1) peel angle: 165°~180° vs carrier tape

2) peel speed: 300mm/min

11.PACKAGING

- 1) Tape & Reel packaging in composite specification 6/8
- 2) Reel and a bag of desiccant shall be packed in Nylon or plastic bag
- 3) Maximum of 5 bags shall be packaged in a inner box
- 4) Maximum of 6 inner box shall be packaged in a outer box

12.Reel Label

Producing the goods label needs to indicate (1) Pb Free (2) RoHS Compliant

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12. STORAGE

- 12-1The solderability of the external electrode may be deteriorated if packages are stored where they are exposed to high humidity. Packages must be stored at 40°C or less and 70% RH or less.
- 12-2 The solderability of the external electrode may be deteriorated if packages are stored where they are exposed to dust or harmful gas (hydrogen chloride, sulfurous acid gas or hydrogen sulfide).
- 12-3 Packaging material may be deformed if packages are stored where they are exposed to heat or direct sun light.
- 12-4 Minimum packages, such as polyvinyl heat—seal packages shall not be opened until just before they are used.
 If opened, use the reels as soon as possible.
- 12-5 Solderability specified in composite specification 4/8 shall be for 6 months from the date of delivery on condition that they are stored at the environment specified clause 12-1 & 12-2.

For those parts which passed more than 6 months shall be checked solderability before it is used.

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| LABLE: | | i = - ` | 00221,01 | C01700001 |
| | | 70mm | | |
| | CODE NO. <≔ | Co1916020 Customer P/N: ITEM P/N: XXXXXXX-LF Q'TY: PCS DATE: Coilmaster Electronics co.,Ltd TEL:+886-3-4228279 FAX:+886-3-42287 | 40mm 40mm | |
| | | INNER BOX LABEL | | |
| | La- | 120mm | | . |
| CODE NO | C0025005 Custo ITEM QTY: N.W: G.W: DATE Coilm | omer: P/N: XXXXXXXX-LF XXX PCS KG KG | Pb | 100mm |
| | | OUT BOX LABEL | | <i></i> <u> </u> |

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